

# Rapsodo

Rapsodo 2.4/5GHz Wifi Module

Model:RAP-6356S



# **Revision History**

Date	Revision Content	Revised By	Version
2014/07/25	-Preliminary	Brian	1.0



## Contents

Co	ontents	2
1.	Introduction	4
2.	Features	5
3.	Deliverables	6
	3.1 Deliverables	6
	3.2 Regulatory certifications	6
4.	General Specification	7
	4.1 General Specification	7
	4.2 Voltages	7
	4.2.1 Absolute Maximum Ratings	7
	4.2.2 Recommended Operating Rating	7
	The module requires two power supplies: VBAT and VDDIO	7
5.	WiFi RF Specification	8
	5.1 2.4GHz RF Specification	8
	5.2 5GHz RF Specification	11
6.	Bluetooth Specification	16
	6.1 Bluetooth Specification	16
7.	Pin Assignments	17
	7.1 Pin Outline	17
	7.2 Pin Definition	17
8.	Dimensions	19
	8.1 Physical Dimensions	19
	8.2 Layout Recommendation	20
9.	External clock reference	21
	9.1 SDIO Pin Description	21
10	.Host Interface Timing Diagram	
	10.1 Power-up Sequence Timing Diagram	22
	10.2 SDIO Default Mode Timing Diagram	24
	10.3 SDIO High Speed Mode Timing Diagram	25
	10.4 SDIO Bus Timing Specifications in SDR Modes	26
	10.5 SDIO Bus Timing Specifications in DDR50 Mode	28
	. Recommended Reflow Profile	
12	Package Information	
	12.1Label	
La	ıbel C→ Inner box label	30
La	ıbel D→ Carton box label	30



### AP6356 Datasheet

12.2 Dimension	. 31
12.3 MSL Level / Storage Condition	. 33



## 1. Introduction

AMPAK Technology would like to announce a low-cost and low-power consumption module which has all of the WiFi and Bluetooth functionalities. The highly integrated module makes the possibilities of web browsing, VoIP, Bluetooth headsets applications. With seamless roaming capabilities and advanced security, also could interact with different vendors' 802.11a/b/g/n/ac 2x2 Access Points in the wireless LAN.

The wireless module complies with IEEE 802.11 a/b/g/n/ac 2x2 MIMO standard and it can achieve up to a speed of 867Mbps with dual stream in 802.11n to connect the wireless LAN. The integrated module provides SDIO/PCIe interface for WiFi, UART / PCM interface for Bluetooth.

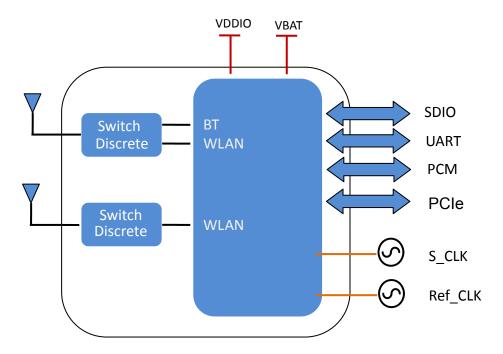
This compact module is a total solution for a combination of WiFi + BT technologies. The module is specifically developed for Smart phones and Portable devices.



## 2. Features

- Lead Free design which is compliant with ROHS requirements.
- 802.11a/b/g/n/ac dual-band radio with virtual-simultaneous dual-band operation
- Dual-stream spatial multiplexing up to 867 Mbps data rate.
- Supports 20, 40, 80 MHz channels with optional SGI(256 QAM modulation)
- Supports IEEE 802.11 ac/n beam forming.
- Supports IEEE 802.15.2 external coexistence interface to optimize bandwidth utilization with other co-located wireless technologies such as LTE, GPS, or WiMAX.
  - Supports standard SDIO/PCIe interfaces.
- BT host digital interface:
  - HCI UART (up to 4 Mbps)
  - PCM for audio data
- Complies with Bluetooth Core Specification Version 4.1 with provisions for supporting future specifications. With Bluetooth Class 1 or Class2 transmitter operation.
- Supports extended synchronous connections (eSCO), for enhanced voice quality by allowing for retransmission of dropped packets.
- Adaptive frequency hopping (AFH) for reducing radio frequency interference.

A simplified block diagram of the module is depicted in the figure below.





## 3. Deliverables

### 3.1 Deliverables

The following products and software will be part of the product.

- Module with packaging
- Evaluation Kits
- Software utility for integration, performance test.
- Product Datasheet.
- Agency certified pre-tested report with the adapter board.



## 4. General Specification

### 4.1 General Specification

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Model Name	AP6356
Product Description	Support WiFi/Bluetooth functionalities
Dimension	L x W x H: 15 x 13 x 1.5 (typical) mm
WiFi Interface	Support SDIO/PCIe
BT Interface	UART / PCM
Operating temperature	-10°C to 65°C
Storage temperature	-40°C to 85°C
Humidity	Operating Humidity 10% to 95% Non-Condensing

### 4.2 Voltages

### 4.2.1 Absolute Maximum Ratings

Symbol	Description	Min.	Max.	Unit
VBAT	Input supply Voltage	-0.5	5.5	V
VDDIO	Digital/Bluetooth/SDIO/ I/O Voltage	-0.5	3.8	V

### 4.2.2 Recommended Operating Rating

The module requires two power supplies: VBAT and VDDIO.

	Min.	Тур.	Max.	Unit
Operating Temperature	-10	25	65	deg.C
VBAT	3.0	3.6	4.8	V
VDDIO	1.7	-	3.6	V



# 5. WiFi RF Specification

## 5.1 2.4GHz RF Specification

Conditions: VBAT=3.6V; VDDIO=3.3V; Temp:25°C

Feature	Description			
WLAN Standard	IEEE 802.11a/b/g/n/ac WiFi compliant			
Frequency Range	2.400 GHz ~ 2.497 GHz (2.4 GHz ISM Band)			
Number of Channels	2.4GHz: Ch1 ~ Ch14			
Modulation	802.11b : DQPSK, DBPSK, CCK			
Wodulation	802.11 g/n : OFDM /64-QAM,16-QAM, QPSK, BPSK			
	802.11b /11Mbps : 16 dBm ± 1.5 dB @ EVM ≤ -9dB			
	802.11g /54Mbps : 15 dBm $\pm$ 1.5 dB @ EVM $\leq$ -25dB			
Output Power	802.11n /MCS7 : 14 dBm $\pm$ 1.5 dB @ EVM $\leq$ -28dB			
	802.11ac/256-QAM(R=3/4) : 13 dBm ± 1.5 dB @ EVM ≤ -30dB			
	802.11ac/256-QAM(R=5/6) : 11 dBm $\pm$ 1.5 dB @ EVM $\leq$ -32dB			
SISO Receive	- 1Mbps PER @ -94 dBm, typical			
Sensitivity (11b,20MHz)	- 2Mbps PER @ -92 dBm, typical			
@8% PER	- 5.5Mbps PER @ -89 dBm, typical			
@0701 EIX	- 11Mbps PER @ -87 dBm, typical			
	- 6Mbps PER @ -91 dBm, typical			
	- 9Mbps PER @ -90 dBm, typical			
SISO Receive	- 12Mbps PER @ -89 dBm, typical			
Sensitivity (11g,20MHz)	- 18Mbps PER @ -86 dBm, typical			
@10% PER	- 24Mbps PER @ -83 dBm, typical			
	- 36Mbps PER @ -80 dBm, typical			
	- 48Mbps PER @ -75 dBm, typical			
	- 54Mbps PER @ -73 dBm, typical			
	- 6Mbps PER @ -92 dBm, typical			
	- 9Mbps PER @ -92 dBm, typical			
MIMO Receive	- 12Mbps PER @ -91 dBm, typical			
Sensitivity (11g,20MHz)	- 18Mbps PER @ -89 dBm, typical			
@10% PER	- 24Mbps PER @ -86 dBm, typical			
W 10/01 LIX	- 36Mbps PER @ -83 dBm, typical			
	- 48Mbps PER @ -78 dBm, typical			
	- 54Mbps PER @ -76 dBm, typical			





	MCC-0 DED & 04 dD for-ign-1
	- MCS=0 PER @ -91 dBm, typical
	- MCS=1 PER @ -88 dBm, typical
SISO Receive	- MCS=2 PER @ -86 dBm, typical
Sensitivity (11n,20MHz)	- MCS=3 PER @ -82 dBm, typical
@10% PER	- MCS=4 PER @ -79 dBm, typical
	- MCS=5 PER @ -74 dBm, typical
	- MCS=6 PER @ -73 dBm, typical
	- MCS=7 PER @ -71 dBm, typical
	- MCS=0 PER @ -92 dBm, typical
	- MCS=1 PER @ -91 dBm, typical
	- MCS=2 PER @ -89 dBm, typical
MIMO Doggivo	- MCS=3 PER @ -86 dBm, typical
MIMO Receive	- MCS=4 PER @ -82 dBm, typical
Sensitivity (11n,20MHz) @10% PER	- MCS=5 PER @ -77 dBm, typical
@1070 FER	- MCS=6 PER @ -75 dBm, typical
	- MCS=7 PER @ -74 dBm, typical
	- MCS=8 PER @ -89 dBm, typical
	- MCS=15 PER @ -70 dBm, typical
	- MCS=0 PER @ -88 dBm, typical
	- MCS=1 PER @ -85 dBm, typical
0100 5	- MCS=2 PER @ -83 dBm, typical
SISO Receive	- MCS=3 PER @ -80 dBm, typical
Sensitivity (11n,40MHz)	- MCS=4 PER @ -76 dBm, typical
@10% PER	- MCS=5 PER @ -72 dBm, typical
	- MCS=6 PER @ -70 dBm, typical
	- MCS=7 PER @ -69 dBm, typical
	- MCS=0 PER @ -90 dBm, typical
	- MCS=1 PER @ -88 dBm, typical
	- MCS=2 PER @ -86 dBm, typical
	- MCS=3 PER @ -83 dBm, typical
MIMO Receive	- MCS=4 PER @ -79 dBm, typical
Sensitivity (11n,40MHz)	- MCS=5 PER @ -75 dBm, typical
@10% PER	- MCS=6 PER @ -73 dBm, typical
	- MCS=7 PER @ -72 dBm, typical
	- MCS=8 PER @ -88 dBm, typical
	- MCS=15 PER @ -69 dBm, typical
SISO Receive	- MCS=0, NSS1 PER @ -90 dBm, typical
-	, , , , , , , , , , , , , , , , , , , ,





Sensitivity	- MCS=1, NSS1 PER @ -87 dBm, typical
(11ac,20MHz) @10%	- MCS=2, NSS1 PER @ -86 dBm, typical
PER	- MCS=3, NSS1 PER @ -82 dBm, typical
	- MCS=4, NSS1 PER @ -79 dBm, typical
	- MCS=5, NSS1 PER @ -74 dBm, typical
	- MCS=6, NSS1 PER @ -72 dBm, typical
	- MCS=7, NSS1 PER @ -71 dBm, typical
	- MCS=8, NSS1 PER @ -68 dBm, typical
	- MCS=0, NSS1 PER @ -90 dBm, typical
	- MCS=1, NSS1 PER @ -89 dBm, typical
	- MCS=2, NSS1 PER @ -88 dBm, typical
	- MCS=3, NSS1 PER @ -85 dBm, typical
MIMO Receive	- MCS=4, NSS1 PER @ -82 dBm, typical
Sensitivity	- MCS=5, NSS1 PER @ -77 dBm, typical
(11ac,20MHz) @10% PER	- MCS=6, NSS1 PER @ -76 dBm, typical
FER	- MCS=7, NSS1 PER @ -74 dBm, typical
	- MCS=8, NSS1 PER @ -70 dBm, typical
	- MCS=0, NSS2 PER @ -90 dBm, typical
	- MCS=8, NSS2 PER @ -66 dBm, typical
	- MCS=0, NSS1 PER @ -87 dBm, typical
	- MCS=1, NSS1 PER @ -85 dBm, typical
	- MCS=2, NSS1 PER @ -83 dBm, typical
SISO Receive	- MCS=3, NSS1 PER @ -80 dBm, typical
Sensitivity	- MCS=4, NSS1 PER @ -76 dBm, typical
(11ac,40MHz) @10%	- MCS=5, NSS1 PER @ -72 dBm, typical
PER	- MCS=6, NSS1 PER @ -70 dBm, typical
	- MCS=7, NSS1 PER @ -69 dBm, typical
	- MCS=8, NSS1 PER @ -64 dBm, typical
	- MCS=9, NSS1 PER @ -63 dBm, typical
	- MCS=0, NSS1 PER @ -89 dBm, typical
	- MCS=1, NSS1 PER @ -88 dBm, typical
MIMO Receive	- MCS=2, NSS1 PER @ -86 dBm, typical
Sensitivity	- MCS=3, NSS1 PER @ -83 dBm, typical
(11ac,40MHz) @10%	- MCS=4, NSS1 PER @ -78 dBm, typical
PER	- MCS=5, NSS1 PER @ -75 dBm, typical
	- MCS=6, NSS1 PER @ -73 dBm, typical
	- MCS=7, NSS1 PER @ -72 dBm, typical



	- MCS=8, NSS1 PER @ -68 dBm, typical
	- MCS=9, NSS1 PER @ -66 dBm, typical
	- MCS=0, NSS2 PER @ -87 dBm, typical
	- MCS=9, NSS2 PER @ -62 dBm, typical
Maximum Input Laval	802.11b : -10 dBm
Maximum Input Level	802.11g/n : -20 dBm
Antenna Reference	Small antennas with 0~2 dBi peak gain

## 5.2 5GHz RF Specification

Conditions: VBAT=3.6V; VDDIO=3.3V; Temp:25°C

Feature	Description		
WLAN Standard	IEEE 802.11a/n 2x2, WiFi compliant		
Frequency Range	4.900 GHz ~ 5.845 GHz (5.0 GHz ISM Band)		
Number of Channels	5.0GHz: Please see the table <sup>1</sup>		
	802.11a : OFDM /64-QAM,16-QAM, QPSK, BPSK		
Modulation	802.11n : OFDM /64-QAM,16-QAM, QPSK, BPSK		
	802.11ac : OFDM /256-QAM		
	802.11a /54Mbps : 13 dBm ± 1.5 dB @ EVM ≤ -25dB		
Output Power	802.11n /MCS7 : 12 dBm ± 1.5 dB @ EVM ≤ -28dB		
	802.11ac /MCS9 : 10 dBm ± 1.5 dB @ EVM ≤ -32dB		
	- 6Mbps PER @ -90 dBm, typical		
	- 9Mbps PER @ -89 dBm, typical		
	- 12Mbps PER @ -88 dBm, typical		
SISO Receive Sensitivity	- 18Mbps PER @ -85 dBm, typical		
(11a,20MHz) @10% PER	- 24Mbps PER @ -82 dBm, typical		
	- 36Mbps PER @ -79 dBm, typical		
	- 48Mbps PER @ -74 dBm, typical		
	- 54Mbps PER @ -72 dBm, typical		





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	- 6Mbps	PER @ -91 dBm, typical
	- 9Mbps	PER @ -91 dBm, typical
	- 12Mbps	PER @ -90 dBm, typical
MIMO Receive Sensitivity	- 18Mbps	PER @ -88 dBm, typical
(11a,20MHz) @10% PER	- 24Mbps	PER @ -85 dBm, typical
	- 36Mbps	PER @ -82 dBm, typical
	- 48Mbps	PER @ -77 dBm, typical
	- 54Mbps	PER @ -73 dBm, typical
	- MCS=0	PER @ -90 dBm, typical
	- MCS=1	PER @ -87 dBm, typical
	- MCS=2	PER @ -85 dBm, typical
SISO Receive Sensitivity	- MCS=3	PER @ -82 dBm, typical
(11n,20MHz) @10% PER	- MCS=4	PER @ -78 dBm, typical
	- MCS=5	PER @ -73 dBm, typical
	- MCS=6	PER @ -72 dBm, typical
	- MCS=7	PER @ -70 dBm, typical
	- MCS=0	PER @ -91 dBm, typical
	- MCS=1	PER @ -90 dBm, typical
	- MCS=2	PER @ -88 dBm, typical
	- MCS=3	PER @ -85 dBm, typical
MIMO Receive Sensitivity	- MCS=4	PER @ -81 dBm, typical
(11n,20MHz) @10% PER	- MCS=5	PER @ -76 dBm, typical
	- MCS=6	PER @ -75 dBm, typical
	- MCS=7	PER @ -73 dBm, typical
	- MCS=8	PER @ -90 dBm, typical
	- MCS=15	PER @ -70 dBm, typical
	- MCS=0	PER @ -87 dBm, typical
	- MCS=1	PER @ -84 dBm, typical
	- MCS=2	PER @ -82 dBm, typical
SISO Receive Sensitivity	- MCS=3	PER @ -79 dBm, typical
(11n,40MHz) @10% PER	- MCS=4	PER @ -75 dBm, typical
	- MCS=5	PER @ -71 dBm, typical
	- MCS=6	PER @ -69 dBm, typical
	- MCS=7	PER @ -68 dBm, typical
MIMO Deserve O 1979	- MCS=0	PER @ -89 dBm, typical
MIMO Receive Sensitivity	- MCS=1	PER @ -87 dBm, typical
(11n,40MHz) @10% PER	- MCS=2	PER @ -85 dBm, typical
	1	





	- MCS=3 PER @ -82 dBm, typical
	- MCS=4 PER @ -78 dBm, typical
	- MCS=5 PER @ -74 dBm, typical
	- MCS=6 PER @ -72 dBm, typical
	- MCS=7 PER @ -71 dBm, typical
	- MCS=8 PER @ -87 dBm, typical
	- MCS=15 PER @ -68 dBm, typical
	- MCS=0, NSS1 PER @ -88 dBm, typical
	- MCS=1, NSS1 PER @ -86 dBm, typical
	- MCS=2, NSS1 PER @ -84 dBm, typical
0.00 0 0 0 0 0 0 0	- MCS=3, NSS1 PER @ -81 dBm, typical
SISO Receive Sensitivity	- MCS=4, NSS1 PER @ -77 dBm, typical
(11ac,20MHz) @10% PER	- MCS=5, NSS1 PER @ -72 dBm, typical
	- MCS=6, NSS1 PER @ -71 dBm, typical
	- MCS=7, NSS1 PER @ -70 dBm, typical
	- MCS=8, NSS1 PER @ -66 dBm, typical
	- MCS=0, NSS1 PER @ -90 dBm, typical
	- MCS=1, NSS1 PER @ -89 dBm, typical
	- MCS=2, NSS1 PER @ -87 dBm, typical
	- MCS=3, NSS1 PER @ -84 dBm, typical
MIMO Pagaiya Sagaitiyity	- MCS=4, NSS1 PER @ -80 dBm, typical
MIMO Receive Sensitivity (11ac,20MHz) @10% PER	- MCS=5, NSS1 PER @ -75 dBm, typical
(1100,2011112) W 10/01 LIX	- MCS=6, NSS1 PER @ -74 dBm, typical
	- MCS=7, NSS1 PER @ -73 dBm, typical
	- MCS=8, NSS1 PER @ -69 dBm, typical
	- MCS=0, NSS2 PER @ -89 dBm, typical
	- MCS=8, NSS2 PER @ -65 dBm, typical
	- MCS=0, NSS1 PER @ -86 dBm, typical
	- MCS=1, NSS1 PER @ -83 dBm, typical
	- MCS=2, NSS1 PER @ -81 dBm, typical
	- MCS=3, NSS1 PER @ -78 dBm, typical
SISO Receive Sensitivity	- MCS=4, NSS1 PER @ -75 dBm, typical
(11ac,40MHz) @10% PER	- MCS=5, NSS1 PER @ -70 dBm, typical
	- MCS=6, NSS1 PER @ -69 dBm, typical
	- MCS=7, NSS1 PER @ -68 dBm, typical
	- MCS=8, NSS1 PER @ -63 dBm, typical
	- MCS=9, NSS1 PER @ -62 dBm, typical





	- MCS=0, NSS1 PER @ -88 dBm, typical				
	- MCS=1, NSS1 PER @ -86 dBm, typical				
	- MCS=2, NSS1 PER @ -84 dBm, typical				
	- MCS=3, NSS1 PER @ -81 dBm, typical				
	- MCS=4, NSS1 PER @ -78 dBm, typical				
MIMO Receive Sensitivity	- MCS=5, NSS1 PER @ -73 dBm, typical				
(11ac,40MHz) @10% PER	- MCS=6, NSS1 PER @ -72 dBm, typical				
	- MCS=7, NSS1 PER @ -71 dBm, typical				
	- MCS=8, NSS1 PER @ -66 dBm, typical				
	- MCS=9, NSS1 PER @ -65 dBm, typical				
	- MCS=0, NSS2 PER @ -86 dBm, typical				
	- MCS=9, NSS2 PER @ -61 dBm, typical				
	- MCS=0, NSS1 PER @ -83 dBm, typical				
	- MCS=1, NSS1 PER @ -80 dBm, typical				
	- MCS=2, NSS1 PER @ -78 dBm, typical				
	- MCS=3, NSS1 PER @ -74 dBm, typical				
SISO Receive Sensitivity	- MCS=4, NSS1 PER @ -71 dBm, typical				
(11ac,80MHz) @10% PER	- MCS=5, NSS1 PER @ -68 dBm, typical				
	- MCS=6, NSS1 PER @ -66 dBm, typical				
	- MCS=7, NSS1 PER @ -64 dBm, typical				
	- MCS=9, NSS1 PER @ -60 dBm, typical				
	- MCS=9, NSS1 PER @ -58 dBm, typical				
	- MCS=0, NSS1 PER @ -84 dBm, typical				
	- MCS=1, NSS1 PER @ -83 dBm, typical				
	- MCS=2, NSS1 PER @ -81 dBm, typical				
	- MCS=3, NSS1 PER @ -77 dBm, typical				
	- MCS=4, NSS1 PER @ -74 dBm, typical				
MIMO Receive Sensitivity	- MCS=5, NSS1 PER @ -71 dBm, typical				
(11ac,80MHz) @10% PER	- MCS=6, NSS1 PER @ -69 dBm, typical				
	- MCS=7, NSS1 PER @ -67 dBm, typical				
	- MCS=8, NSS1 PER @ -63 dBm, typical				
	- MCS=9, NSS1 PER @ -61 dBm, typical				
	- MCS=0, NSS2 PER @ -82 dBm, typical				
	- MCS=9, NSS2 PER @ -57 dBm, typical				
Maximum Input Level	802.11a/n : -30 dBm				
Antenna Reference	Small antennas with 0~2 dBi peak gain				



### <sup>1</sup>5GHz(20MHz) Channel table

Numbers   frequencies(MHz)	Band (GHz)	Operating Channel	Channel center
5.15GHz~5.25GHz       40       5200         44       5220         48       5240         52       5260         56       5280         60       5300         64       5320         100       5500         104       5520         108       5540         112       5560         116       5580         124       5620         128       5640         132       5660         136       5680         140       5700         149       5745         153       5765         157       5785	ballu (GHZ)	Numbers	frequencies(MHz)
5.15GHz~5.25GHz  44 5220  48 5240  52 5260  56 5280  60 5300  64 5320  100 5500  104 5520  108 5540  112 5560  116 5580  5.5GHz~5.7GHz  120 5600  124 5620  128 5640  132 5660  136 5680  140 5700  149 5745  5.725GHz~5.825GHz  153 5765  157 5785		36	5180
44       5220         48       5240         52       5260         56       5280         60       5300         64       5320         100       5500         104       5520         108       5540         112       5560         116       5580         5.5GHz~5.7GHz       120       5600         124       5620         128       5640         132       5660         136       5680         140       5700         149       5745         153       5765         157       5785	F 1FCU-~F 2FCU-	40	5200
5.25GHz~5.35GHz  56  5280  56  5280  60  5300  64  5320  100  5500  104  5520  108  5540  112  5560  116  5580  5.5GHz~5.7GHz  120  5600  124  5620  128  5640  132  5660  136  5680  140  5700  149  5745  5585	3.13GHZ 3.23GHZ	44	5220
5.25GHz~5.35GHz     56     5280       60     5300       64     5320       100     5500       104     5520       108     5540       112     5560       116     5580       5.5GHz~5.7GHz     120     5600       124     5620       128     5640       132     5660       136     5680       140     5700       149     5745       153     5765       157     5785		48	5240
5.25GHz~5.35GHz  60 5300 64 5320 100 5500 104 5520 108 5540 112 5560 116 5580 5.5GHz~5.7GHz 120 5600 124 5620 128 5640 132 5660 136 5680 140 5700 149 5745 5.725GHz~5.825GHz 153 5765 5785		52	5260
60       5300         64       5320         100       5500         104       5520         108       5540         112       5560         116       5580         5.5GHz~5.7GHz       120       5600         124       5620         128       5640         132       5660         136       5680         140       5700         149       5745         5.725GHz~5.825GHz       153       5765         157       5785	E 3EGU-~E 3EGU-	56	5280
100 5500  104 5520  108 5540  112 5560  116 5580  5.5GHz~5.7GHz  120 5600  124 5620  128 5640  132 5660  136 5680  140 5700  149 5745  5.725GHz~5.825GHz  153 5765  5785	5.25GHZ 5.55GHZ	60	5300
104 5520 108 5540 112 5560 116 5580 5.5GHz~5.7GHz 120 5600 124 5620 128 5640 132 5660 136 5680 140 5700 149 5745 5.725GHz~5.825GHz 153 5765 5785		64	5320
108 5540  112 5560  116 5580  116 5580  120 5600  124 5620  128 5640  132 5660  136 5680  140 5700  149 5745  153 5765  157 5785		100	5500
5.5GHz~5.7GHz  112  5560  116  5580  5.5GHz~5.7GHz  120  5600  124  5620  128  5640  132  5660  136  5680  140  5700  149  5745  5.725GHz~5.825GHz  153  5765  5785		104	5520
5.5GHz~5.7GHz  116  5580  120  5600  124  5620  128  5640  132  5660  136  5680  140  5700  149  5745  5.725GHz~5.825GHz  153  5765  5785		108	5540
5.5GHz~5.7GHz     120     5600       124     5620       128     5640       132     5660       136     5680       140     5700       149     5745       5.725GHz~5.825GHz     153     5765       157     5785		112	5560
124 5620 128 5640 132 5660 136 5680 140 5700 149 5745 153 5765 157 5785		116	5580
128 5640 132 5660 136 5680 140 5700 149 5745 153 5765 15725GHz~5.825GHz 157 5785	5.5GHz~5.7GHz	120	5600
132 5660 136 5680 140 5700 149 5745 153 5765 157 5785		124	5620
136     5680       140     5700       149     5745       153     5765       157     5785		128	5640
140 5700 149 5745 5.725GHz~5.825GHz 153 5765 157 5785		132	5660
149 5745 5.725GHz~5.825GHz 153 5765 157 5785		136	5680
5.725GHz~5.825GHz 153 5765 157 5785		140	5700
5.725GHz~5.825GHz 157 5785		149	5745
157 5785	F 72FCH-~F 02FCH-	153	5765
161 5805	3.723UHZ 3.825UHZ	157	5785
		161	5805



# 6. Bluetooth Specification

## 6.1 Bluetooth Specification

Conditions · VBAT=3 6V · VDDIO=3 3V · Temp·25°C

Feature	Description						
General Specification							
Bluetooth Standard	Bluetooth V4.1	Bluetooth V4.1 of 1, 2 and 3 Mbps.					
Host Interface	UART						
Antenna Reference	Small antennas	with 0~2 dBi peak	gain				
Frequency Band	2402 MHz ~ 24	80 MHz					
Number of Channels	79 channels						
Modulation	FHSS, GFSK, [	FHSS, GFSK, DPSK, DQPSK					
RF Specification							
	Min.	Typical.	Max.				
Output Power (Class 1.5)		10 dBm					
Output Power (Class 2)		2 dBm					
Sensitivity @ BER=0.1%	-86 dBm						
for GFSK (1Mbps)		-86 dBm					
for GFSK (1Mbps) Sensitivity @ BER=0.01% for π/4-DQPSK (2Mbps)		-86 dBm					
Sensitivity @ BER=0.01%							
Sensitivity @ BER=0.01% for π/4-DQPSK (2Mbps) Sensitivity @ BER=0.01%	GFSK (1Mbps):	-86 dBm -80 dBm					
Sensitivity @ BER=0.01% for π/4-DQPSK (2Mbps) Sensitivity @ BER=0.01%	GFSK (1Mbps): π/4-DQPSK (2N	-86 dBm -80 dBm :-20dBm					



# 7. Pin Assignments

### 7.1 Pin Outline





### 7.2 Pin Definition

NO	Name	Туре	Description				
1	GND	_	Ground connections				
2	WL/BT_ANT0	I/O	RF I/O port0				
3	GND	_	Ground connections				
4	GND	_	Ground connections				
5	GND	_	Ground connections				
6	GND	_	Ground connections				
7	GND	_	Ground connections				
8	GND	_	Ground connections				
9	WL_ANT1	I/O	RF I/O port1				
10	GND	_	Ground connections				
11	GND	_	Ground connections				
12	PCIE_PERST	I	PCIE system reset				
13	XTAL_OUT	0	External Crystal out				



14	XTAL IN	I	External Crystal in/ Single clock source in
15	WL_REG_ON	I	Low asserting reset for WiFi core
16	WL_HOST_WAKE	0	WLAN to wake-up HOST
17	SDIO_DATA_CMD	I/O	SDIO command line
18	SDIO_DATA_CLK	I/O	SDIO clock line
19	SDIO_DATA_3	I/O	SDIO data line 3
20	SDIO_DATA_2	I/O	SDIO data line 2
21	SDIO_DATA_0	I/O	SDIO data line 0
22	SDIO_DATA_1	I/O	SDIO data line 1
23	GND	_	Ground connections
24	PCIE_PME_L	0	PCIE power management event output
25	VIN_LDO	Р	Internal Buck voltage generation pin
26	VIN_LDO_OUT	Р	Internal Buck voltage generation pin
27	PCM_SYNC	I/O	PCM sync signal
28	PCM_IN	I	PCM data input
29	PCM_OUT	0	PCM Data output
30	PCM_CLK	I/O	PCM clock
31	LPO	I	External Low Power Clock input (32.768KHz)
32	GND	_	Ground connections
33	PCIE_REFCLK_N	I	PCIE differential clock inputs 100MHz differential
34	VDDIO	Р	I/O Voltage supply input
35	PCIE_REFCLK_P	I	PCIE differential clock inputs 100MHz differential
36	VBAT	Р	Main power voltage source input
37	PCIE_CLKREQ_L	0	PCIE clock request signal
38	BT_REG_ON	I	Low asserting reset for Bluetooth core
39	GND		Ground connections
40	UART_TXD	0	Bluetooth UART interface
41	UART_RXD	I	Bluetooth UART interface
42	UART_RTS_N	0	Bluetooth UART interface
43	UART_CTS_N	I	Bluetooth UART interface
44	PCIE_RDN	I	PCIE receiver differential pair
45	PCIE_RDP	I	PCIE receiver differential pair
46	PCIE_TDN	0	PCIE transmitter differential pair
47	PCIE_TDP	0	PCIE transmitter differential pair
48	GPIO8_9	I	Mode selection, 1=PCIE mode , 0=SDIO mode
49	BT_WAKE	I	HOST wake-up Bluetooth device
			Bluetooth device to wake-up HOST



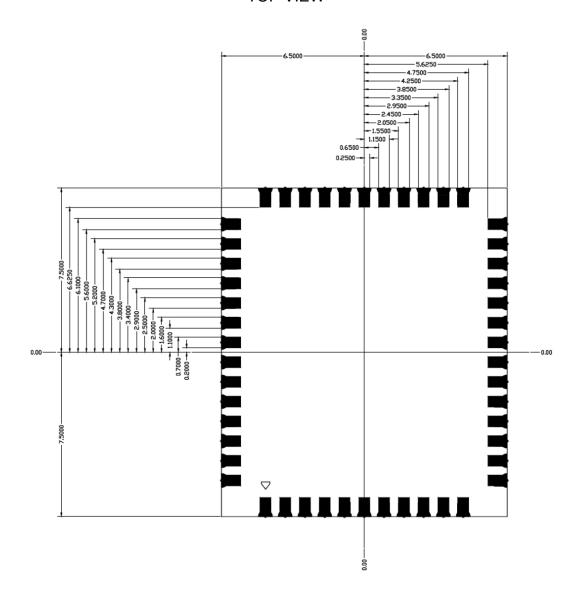
## 8. Dimensions

## 8.1 Physical Dimensions

(Unit: mm)

< TOP VIEW > < Side View > 13+/-0.1 1.5 +/- 0.1

< TOP VIEW >

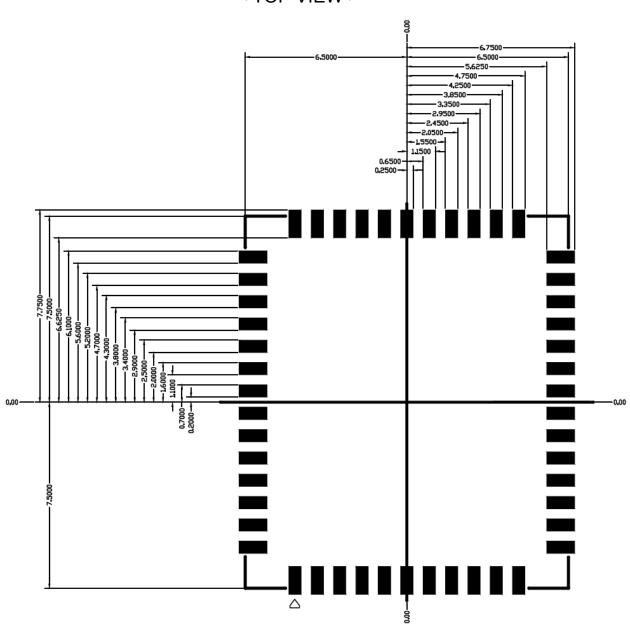




## 8.2 Layout Recommendation

(Unit: mm)

### < TOP VIEW >





## External clock reference

### External LPO signal characteristics

Parameter	Specification	Units
Nominal input frequency	32.768	kHz
Frequency accuracy	±30	ppm
Duty cycle	30 - 70	%
Input signal amplitude	1600 to 3300	mV, p-p
Signal type	Square-wave or sine-wave	-
Input impedance	>100k	Ω
Input impedance	<5	pF
Clock jitter (integrated over 300Hz – 15KHz)	<1	Hz
Output high voltage	0.7Vio - Vio	V

### 9.1 SDIO Pin Description

The module supports SDIO version 3.0 for all 1.8V 4-bit UHSI speeds: SDR50(100 Mbps),SDR104(208MHz) and DDR50(50MHz, dual rates) in addition to the 3.3V default speed(25MHz) and high speed (50 MHz). It has the ability to stop the SDIO clock and map the interrupt signal into a GPIO pin. This 'out-of-band' interrupt signal notifies the host when the WLAN device wants to turn on the SDIO interface. The ability to force the control of the gated clocks from within the WLAN chip is also provided.

- Function 0 Standard SDIO function (Max BlockSize / ByteCount = 32B)
- Function 1 Backplane Function to access the internal System On Chip (SOC) address space (Max BlockSize / ByteCount = 64B)
- Function 2 WLAN Function for efficient WLAN packet transfer through DMA (Max BlockSize/ByteCount=512B)

### SDIO Pin Description

	SD 4-Bit Mode				
DATA0	Data Line 0				
DATA1	Data Line 1 or Interrupt				
DATA2	Data Line 2 or Read Wait				
DATA3	Data Line 3				
CLK	Clock				
CMD	Command Line				



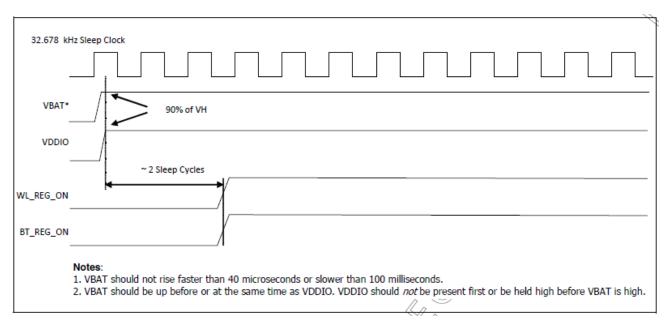
## **Host Interface Timing Diagram**

### 10.1 Power-up Sequence Timing Diagram

The module has signals that allow the host to control power consumption by enabling or disabling the Bluetooth, WLAN and internal regulator blocks. These signals are described below.

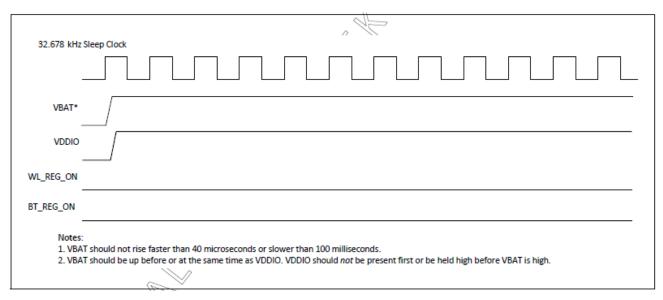
Additionally, diagrams are provided to indicate proper sequencing of the signals for carious operating states. The timing value indicated are minimum required values: longer delays are also acceptable.

- WL REG ON: Used by the PMU to power up or power down the internal regulators used by the WLAN section. When this pin is high, the regulators are enabled and the WLAN section is out of reset. When this pin is low the WLAN section is in reset.
- BT REG ON: Used by the PMU to power up or power down the internal regulators used by the BT section. Low asserting reset for Bluetooth. This pin has no effect on WLAN and does not control any PMU functions. This pin must be driven high or low (not left floating).

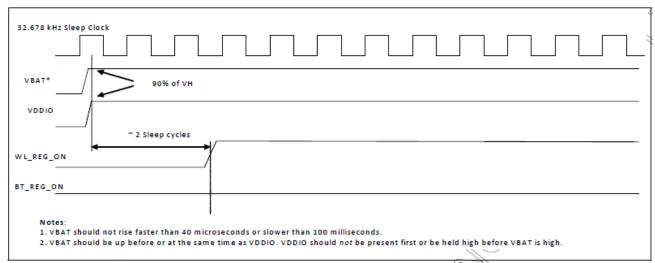


WLAN=ON, Bluetooth=ON

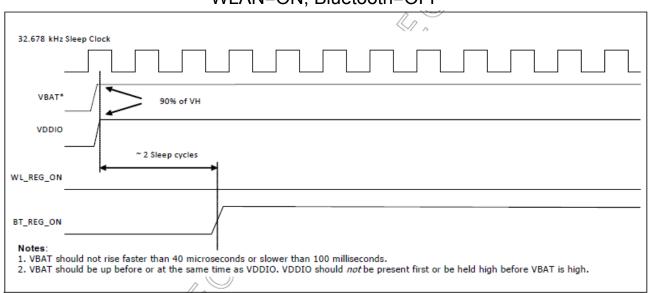




### WLAN=OFF, Bluetooth=OFF



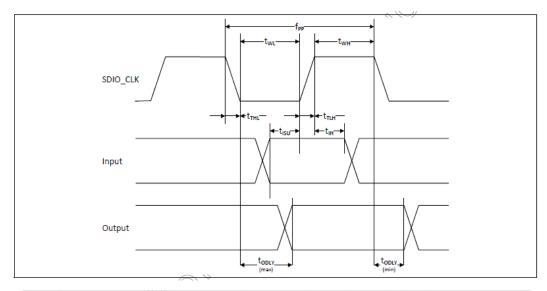
### WLAN=ON, Bluetooth=OFF



### WLAN=OFF, Bluetooth=ON



## 10.2 SDIO Default Mode Timing Diagram



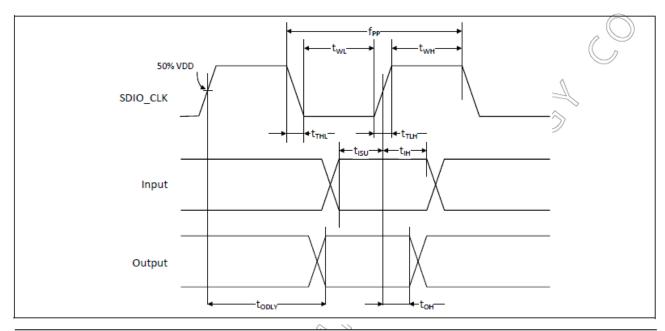
Parameter	Symbol	Minimum	Typical	Maximum	Unit		
SDIO CLK (All values are referred to minimum VIH and maximum VIL <sup>b</sup> )							
Frequency – Data Transfer mode	fPP	0		25	MHz		
Frequency – Identification mode	fOD	0		400	kHz		
Clock low time	tWL	10	-0	-9	ns		
Clock high time	tWH	10	<u></u> 33	- 13	ns		
Clock rise time	tTLH			10	ns		
Clock low time	tTHL			10	ns		
Inputs: CMD, DAT (referenced to CLK)							
Input setup time	tISU	5	0_0	_	ns O		
Input hold time	tIH	5	6. <del>-</del>	i <del>-</del>	ns		
Outputs: CMD, DAT (referenced to CLK)				1			
Output delay time – Data Transfer mode	tODLY	0	-	14	ns		
Output delay time – Identification mode	tODLY	0	_	50 🖒	ns		

a. Timing is based on CL  $\leq$  40pF load on CMD and Data.

b.  $min(Vih) = 0.7 \times VDDIO$  and  $max(Vil) = 0.2 \times VDDIO$ .



## 10.3 SDIO High Speed Mode Timing Diagram



Parameter	Symbol	Minimum	Typical	Maximum	Unit				
SDIO CLK (all values are referred to minimum VIH and maximum VIL <sup>b</sup> )									
Frequency – Data Transfer Mode OfPP 0 – 50 MHz									
Frequency – Identification Mode	fOD	0	-	400	kHz				
Clock low time	tWL	7	_	_	ns				
Clock high time	tWH	7	_	_	ns				
Clock rise time	tTLH	_	_	3	ns				
Clock low time	tTHL	_	_	3	ns				
Inputs: CMD, DAT (referenced to CLK)									
Input setup Time	tISU	6	_	_	ns				
Input hold Time	tIH	2	_	_	ns				
Outputs: CMD, DAT (referenced to CLK)									
Output delay time – Data Transfer Mode	tODLY	-	_	14	ns				
Output hold time	tOH	2.5	_	_	ns				
Total system capacitance (each line)	CL	_	_	40	pF				

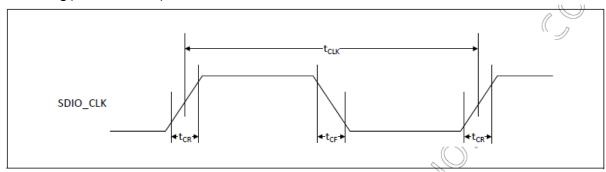
a Timing is based on CL  $\leq$  40 pF load on CMD and Data.

to min(Vih) = 0.7 × VDDIO and max(Vil) = 0.2 × VDDIO.



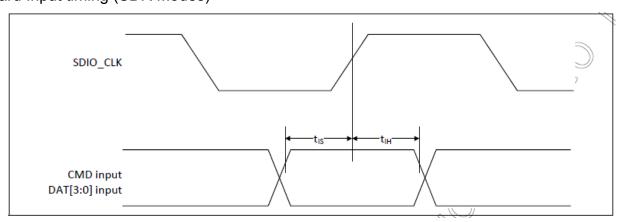
## 10.4 SDIO Bus Timing Specifications in SDR Modes

### Clock timing(SDR Modes)



Parameter	Symbol	Minimum	Maximum	Unit	Comments
_	t <sub>CLK</sub>	40	_	ns	SDR12 mode
		20		ns	SDR25 mode
		10	- 4/	ns	SDR50 mode
		4.8	- 🧸	√ns	SDR104 mode
_	t <sub>CR</sub> , t <sub>CF</sub>	-	0.2 × tclk	ns	t <sub>CR</sub> , t <sub>CF</sub> < 2.00 ns (max) @100 MHz, C <sub>CARD</sub> = 10 pF
					$t_{CR}$ , $t_{CF}$ < 0.96 ns (max) @208 MHz, $C_{CARD}$ = 10 pF
Clock duty	_	30	70	%	-

### Card Input timing (SDR Modes)

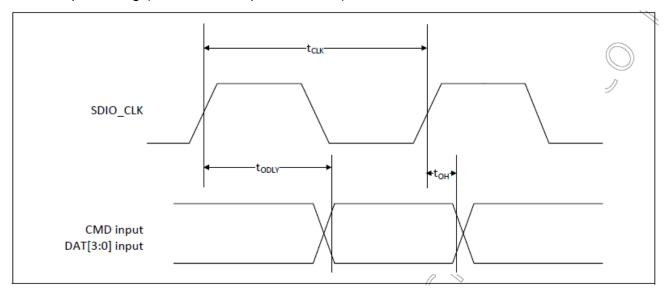


Symbol	Minimum	Maximum	Unit	Comments	
SDR104 M	ode				
t <sub>IS</sub>	1.70 <sup>a</sup>	_	ns	C <sub>CARD</sub> = 10 pF, VCT = 0.975V	
t <sub>IH</sub>	0.80	-	ns	CARD = 5 pF, VCT = 0.975V	
SDR50 Mod	de				
t <sub>IS</sub>	3.00	-	ns 🌾	C <sub>CARD</sub> = 10 pF, VCT = 0.975V	
t <sub>IH</sub>	0.80	-	ns	C <sub>CARD</sub> = 5 pF, VCT = 0.975V	

a. SDIO 3.0 specification value is 1.40 ns.



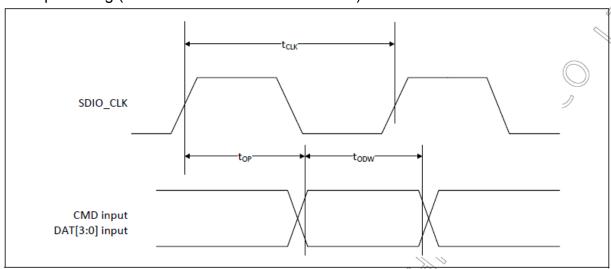
#### Card output timing (SDR Modes up to 100MHz)



Symbol	Minimum	Maximum	Unit	Comments
t <sub>ODLY</sub>	_	7.85 <sup>a</sup>	ns	t <sub>CLK</sub> ≥ 10 ns C <sub>L</sub> = 30 pF using driver type B for SDR50
t <sub>ODLY</sub>	_	14.0	ns	t <sub>CLK</sub> ≥ 20 ns C <sub>L</sub> = 40 pF using for SDR12, SDR25
t <sub>OH</sub>	1.5	_	ns	Hold time at the t <sub>ODLY</sub> (min) C <sub>L</sub> = 15 pF

a. SDIO 3.0 specification value is 7.5 ns.

### Card output timing (SDR Modes 100MHz to 208MHz)

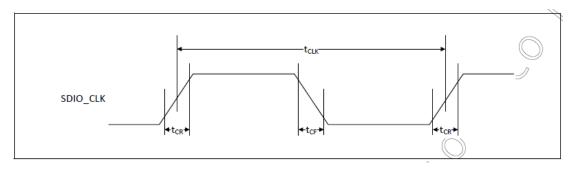


Symbol	Minimum	Maximum	Unit	Comments
t <sub>OP</sub>	0	2	UI	Card output phase
Δt <sub>OP</sub>	-350	+1550	ps	Delay variation due to temp change after tuning
t <sub>ODW</sub>	0.60	-	UI	t <sub>ODW</sub> =2.88 ns @208 MHz

- $\Delta t_{OP}$  = +1550 ps for junction temperature of  $\Delta t_{OP}$  = 90 degrees during operation
- $\Delta t_{OP} = -350$  ps for junction temperature of  $\Delta t_{OP} = -20$  degrees during operation
- $\Delta t_{OP}$  = +2600 ps for junction temperature of  $\Delta t_{OP}$  = -20 to +125 degrees during operation

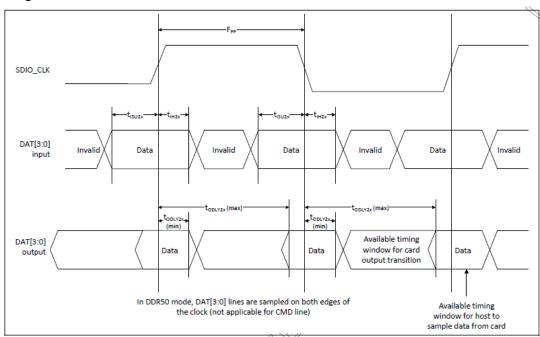


## 10.5 SDIO Bus Timing Specifications in DDR50 Mode



Parameter	Symbol	Minimum	Maximum	Unit	Comments	
_	t <sub>CLK</sub>	20	_	ns	DDR50 mode	
_	$t_{CR}$ , $t_{CF}$	-	0.2 × tCLK	ns	t <sub>CR</sub> , t <sub>CF</sub> < 4.00 ns (max) @50 MHz, C <sub>CARD</sub> = 10 pF	
Clock duty	_	45	55	% (	_	

### **Data Timing**



Parameter	Symbol	Minimum	Maximum	Unit	Comments
Input CMD		<u></u>			
Input setup time	t <sub>ISU</sub>	6	-	ns	C <sub>CARD</sub> < 10pF (1 Card)
Input hold time	t <sub>IH</sub> //	0.8	-	ns	C <sub>CARD</sub> < 10pF (1 Card)
Output CMD	- W	>			
Output delay time	t <sub>OQLY</sub>	-	13.7	ns	C <sub>CARD</sub> < 30pF (1 Card)
Output hold time	¢o⊬_	1.5	-	ns	C <sub>CARD</sub> < 15pF (1 Card)
Input DAT					
Input setup time	<sup>∖</sup> t <sub>ISU2x</sub>	3	-	ns	C <sub>CARD</sub> < 10pF (1 Card)
Input hold time	t <sub>IH2x</sub>	0.8	-	ns	C <sub>CARD</sub> < 10pF (1 Card)
Output DAT					
Output delay time	t <sub>ODLY2x</sub>	-	7.85 <sup>a</sup>	ns	C <sub>CARD</sub> < 25pF (1 Card)
Output hold time	t <sub>ODLY2x</sub>	1.5	_	ns	C <sub>CARD</sub> < 15pF (1 Card)

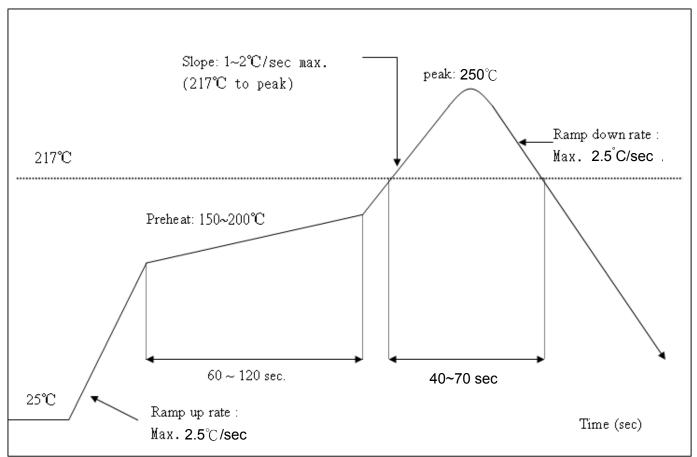
a SDIO 3.0 specification value is 7.0 ns.



## 11. Recommended Reflow Profile

Referred to IPC/JEDEC standard.

Peak Temperature : <250°C Number of Times : ≤2 times





## 12. Package Information

### 12.1Label

Label A→ Anti-static and humidity notice



#### Label B→ MSL caution / Storage Condition

(	Caution This bag contains MOISTURE-SENSITIVE DEVICES Haland, see adjace but code label
1.	Calculated shelf life in sealed bag: 12 months at <40°C and <90% relative humidity (RH)
2.	Peak package body temperature: "C"   Tolank, see adjacent bar code label
3.	After bag is opened, devices that will be subjected to reflow solder or other high temperature process must be
	a) Mounted within:hours of factory conditions ≤30°C/60% RH, or
	b) Stored per J-STD-033
4.	Devices require bake, before mounting, if:
	a) Humidity Indicator Card reads >10% for level 2a - 5a devices or >60% for level 2 devices when read at 23 $\pm$ 5 $^\circ$
	b) 3a or 3b are not met
5.	If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure
Ba	ag Seal Date:f blank, see adjacent bar code label
	Note: Level and body temperature defined by IPC/JEDEC J-STD-020

#### Label C→ Inner box label.

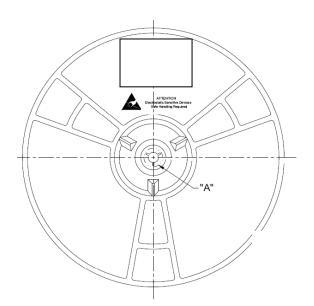
### Label D→ Carton box label .

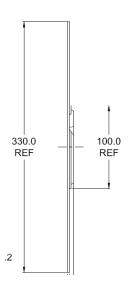




### 12.2 Dimension

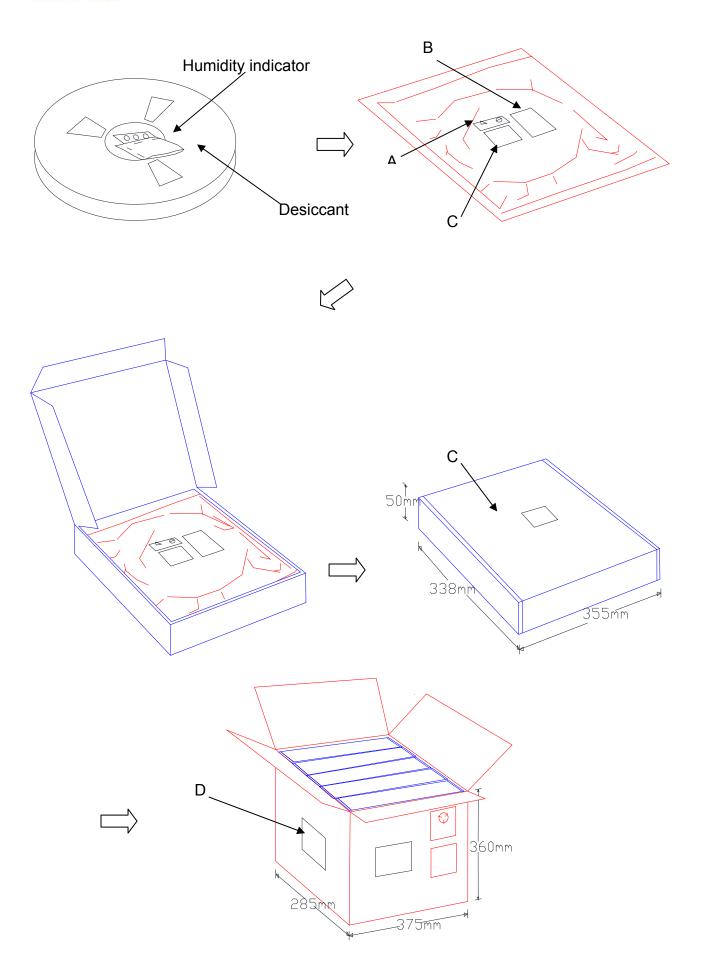
- 1. 10 sprocket hole pitch cumulative tolerance  $\pm 0.20$ .
- 2. Carrier camber is within 1 mm in 250 mm.
- 3. Material: Black Conductive Polystyrene Alloy.
- 4. All dimensions meet EIA-481-D requirements.
- 5. Thickness: 0.30±0.05mm.
- 6. Packing length per 22" reel: 98.5 Meters.(1:3)
- 7. Component load per 13" reel: 1500 pcs.













## 12.3 MSL Level / Storage Condition

LEVEL
Caution 4
This bag contains 4
MOISTURE-SENSITIVE DEVICES
Do not open except under controlled conditions
1. Calculated shelf life in sealed bag: 12 months at< 40° and
< 90% relative humidity(RH)
225°C 240°C 250°C 260°C
2. Peak package body temperature:
<ol> <li>After bag is opened, devices that will be subjected to reflow solder or other high temperature process must</li> <li>a) Mounted within: 48 hours of factory conditions</li> <li>&lt;30°C/60% RH, OR</li> <li>b) Stored at &lt;10% RH</li> </ol>
<ol> <li>Devices require bake, before mounting, if:         <ul> <li>a)Humidity Indicator Card is&gt;10%when read at 23±5℃</li> <li>b)3a or 3b not met</li> </ul> </li> </ol>
5. If baking is required, devices may be baked for 24 hours at 125±5℃
Note: If device containers cannot be subjected to high temperature or shorter bake times are desired,
reference IPC/JEDEC J-STD-033 for bake procedure
Bag Seal Date: See-SEAL DATELABEL
Note:Level and body temperature defined by IPC/JEDED J-STD-020

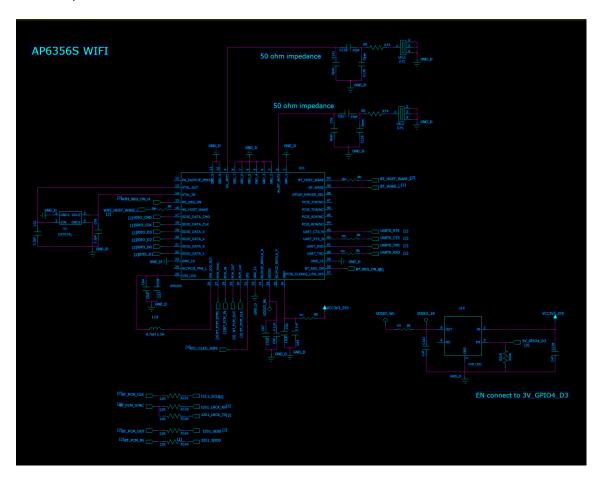
**※NOTE**: Accumulated baking time should not exceed 96hrs

#### **Trace Antenna Design**

The crystal 37.4Mhz is feed to the AP6356S module as a reference clock. With the tuning of C21 and C56 to be 3.3pF determine the accuracy of the clock given to the wifi module was choosen so that the carrier frequency are under +/-20ppm.

C132 and C92 are set to be 10pF and the trace going to the antenna are controlled to be 50ohm impedance.

Ufl2 and UFL3 uses molex With manufacturing partnumber **0734120110** is a micro coaxial connector 50 ohm SMD,



#### **Antenna requirements**

RF Antenna is patch Flat antenna 2.4/5GHz from Molex with manufacturing part number 1461530100 4.5dBi for 5GHz and 4.5dBi for 2.4GHz, it's a center feed design PIFA with a ground plane impedance.

#### **FCC Statement**

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) This device may not cause harmful interference, and
- (2) this device must accept

any interference received, including interference that may cause undesired operation.

Any Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

The modular can be installed or integrated in mobile or fix devices only. This modular cannot be installed in any portable device.

#### FCC Radiation Exposure Statement

This modular complies with FCC RF radiation exposure limits set forth for an uncontrolled environment. This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter. This modular must be installed and operated with a minimum distance of 20 cm between the radiator and user body.

If the FCC identification number is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording such as the following: "Contains Transmitter Module FCC ID: 2AH3O-AP6356S Or Contains FCC ID: 2AH3O-AP6356S"

When the module is installed inside another device, the user manual of the host must contain below warning statements;

- 1. This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:
- (1) This device may not cause harmful interference.
- (2) This device must accept any interference received, including interference that may cause undesired operation.
- 2. Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

The devices must be installed and used in strict accordance with the manufacturer's instructions as described in the user documentation that comes with the product.

Any company of the host device which install this modular with Single modular approval should perform the test of radiated emissionand spurious emission according to FCC part 15C: 15.247 and 15.209 requirement, Only if the test result comply with FCC part 15C: 15.247 and 15.209 requirement, then the host can be sold legally.

This module has been tested and found to comply with part 15C and E requirements for Modular Approval. The modular transmitter is only FCC authorized for the specific rule parts (i.e., FCC transmitter rules) listed on the grant, and that the host product manufacturer is responsible for compliance to any other FCC rules that apply to the host not covered by the modular transmitter grant of certification. If the grantee markets their product as being Part 15 Subpart B compliant (when it also contains unintentional-radiator digital circuity), then the grantee shall provide a notice stating that the final host product still requires Part 15 Subpart B compliance testing with the modular transmitter installed.